



Republic of the Philippines
 DEPARTMENT OF EDUCATION
 REGION IV – A (CALABARZON)
 Gate 2-Karangalan Drive
 Cainta, Rizal



SUBJECT : **BID BULLETIN NO. 1**

PROJECT : **REPAIR AND REHABILITATION OF SCHOOL BUILDINGS IN VARIOUS SITES UNDER THE CY 2013 BASIC EDUCATIONAL FACILITIES FUND (BEFF)**

DATE : **SEPTEMBER 19, 2013**

This Bid Bulletin pertains to the latest instructions for the above mentioned project which shall form an integral part of the bid documents.

- a. The **ten (10) envelope system** shall be observed. Each Bidder shall submit one (1) original and two (2) copies of the Technical Component and one (1) original and two (2) copies of the Financial Component of its bid, hence the envelope sealing illustration at the last part of the Bid Document is hereby revised as follows:

Original Technical Component	} Original Copy – Technical & Financial Component	} Bid for Financial and Technical Component (one big envelope)
Original Financial Component		
Copy 1 Technical Component	} Copy 1 - Technical & Financial Component	
Copy 1 Financial Component		
Copy 2 Technical Component	} Copy 2 - Technical & Financial Component	
Copy 2 Financial Component		

- b. **Section III – Bid Data Sheet 20.1 – Sealing and Marking of Bids.** All Class “A” Eligibility Documents, such as the SEC, DTI, or the CDA registration certificate, the Mayor’s Permit and the PCAB License shall be authenticated by the issuing agencies concerned.
- c. **Ronggot ES in Calamba City under Cluster 11** is hereby removed from the list, hence, the Approved Budget for the Contract (ABC) is **PhP4,851,000.00** pesos.
- d. Soft copy in compact disc (CD) or flash drive of the duly priced Bill of Quantities and the Program of Works and Detailed Estimates shall be placed inside the **Financial Component envelope**.
- e. Those provisions not expressly modified, revised and/or superceded shall remain to be in effect.

Please be guided accordingly.


ANN GERALYN T. PELIAS
 Chief Administrative Officer
 Chairman, Bids and Awards Committee

Incl.: Illustration of the Envelope System

ENVELOPE SYSTEM

